ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pa	IPC, Bannock	burn, Illinois. A	ll rights reserved u ntions.	nder both	This docume level parts, t	ent is a declar the declaratio	ration of n encom	the substance the substance passes all low	s within th er level ma	e manufactur aterials for w	rer listed ite hich the ma	em. Note anufactu	e: if the item is an a arer has engineering	assembly with low g responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Ty http://www.ipc.org/IPC-175x Distribut				*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information				
Supplier Information															
Company name*	Company uni	Company unique ID			Unique ID Authority					Response Date*					
nsemi											2025-06-	2025-06-07			
Contact Name Title - C			Fitle - Contact			Phone - Contact*					Email - Contact*				
Product-Env-Stewards Prod			Product Enviro Compliance			NA					Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - R			itle - Representative			Phone - Representative*				Email - Representative*					
Product-Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Requester Item Number	Mfr Iter	n Number	Mfr Item Name			Effective Da	ate Ve	ersion	Manufacturing Site		v	Veight*	UOM	Unit Type	
	NOIP1S	N0300A-QTI	PYTHON 300 Mono LVDS, Tape on Lid		e on Lid	2025-06-07			ТНА		1	056.06	mg	Each	
Aanufacturing Proccess Informa	ation		· 			1							1		
Terminal Plating / Grid Array M	Iaterial '	Ferminal Base A	Alloy J	y J-STD-020 MSL		Peak Process Body Tem		ody Temperat	rature Max Time at Peak		Temperatu	Temperature Number of Reflow Cycles		/cles	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 3		3		260		C	30		second	ls 3			
Comments															
TTENTION: MSL 3 Rated item requir	es Bake and I	Dry Pack (after	electrical test)												
or more information regarding materia	l composition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Ceramic Substrate	665.12	mg	Supplier	Cobalt (Co)	7440-48-4		0.0665	mg
			Supplier	Molybdenum (Mo)	7439-98-7		0.0665	mg
			Supplier	Tungsten (W)	7440-33-7		7.9814	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		41.9026	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		589.2963	mg
			В	Nickel (Ni)	7440-02-0		1.8623	mg
			Supplier	Gold (Au)	7440-57-5		1.3302	mg
			Supplier	Chromium Trioxide (Cr2O3)	1308-38-9		22.614	mg
Die	119.22	mg	Supplier	Silicon (Si)	7440-21-3		119.22	mg
Die Attach	48.62	mg	Supplier	Silver (Ag)	7440-22-4		41.327	mg
			Supplier	Epoxy resins	129915-35-1		7.293	mg
Glass Attach Epoxy	3.41	mg	Supplier	2,3-epoxypropyl-trimethoxysilan	2530-83-8		0.2933	mg
			Supplier	N-[3- (Trimethoxysilyl)propyl]ethylenediamine	1760-24-3		0.2353	mg
			Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		1.4186	mg
			Supplier	4,4'-Diaminodiphenyl Sulfone (DDS-4,4')	80-08-0		0.0102	mg
			Supplier	Filler (SiO2?C2H6Cl2Si)	68611-44-9		1.364	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0887	mg
Glass Lid /Cap	219.48	mg	Supplier	Boron Trioxide (B2O3)	1303-86-2		18.4363	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		130.5467	mg
			Supplier	Barium Monoxide (BaO)	1304-28-5		17.9974	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		17.3828	mg
			Supplier	Calcium Monoxide (CaO)	1305-78-8		35.1168	mg
Wire Bond - Al	0.21	mg	Supplier	Aluminum (Al)	7429-90-5		0.21	mg